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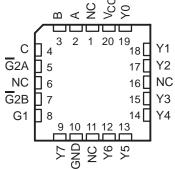
- EPIC ™ (Enhanced-Performance Implanted CMOS) 2-µ Process
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at V_{CC}, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 > 2 V at V_{CC}, T_A = 25°C
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17
- Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), Thin Shrink Small-Outline (PW), Ceramic Flat (W) Packages, Chip Carriers (FK), and (J) 300-mil DIPs

description

These 3-line to 8-line decoders/demultiplexers are designed for 2.7-V to 5.5-V $\rm V_{CC}$ operation.

The 'LV138 are designed for high-performance memory-decoding or data-routing applications requiring very short propagation delay times. In high-performance memory systems, this decoder can be used to minimize the effects of system decoding. When employed with high-speed utilizing a fast enable circuit, the delay times of this decoder and the enable time of the memory are usually less than the typical access time of the memory. This means that the effective system delay introduced by the decoder is negligible.

SN74LV138 D,	. J OR W PACKAGE DB, OR PW PACKAGE OP VIEW)
A [1 B [2 C [3 G2A [4 G2B [5 G1 [6 Y7 [7 GND [8	16] V _{CC} 15] Y0 14] Y1 13] Y2 12] Y3 11] Y4 10] Y5 9] Y6
	FK PACKAGE OP VIEW)



NC - No internal connection

The conditions at the binary-select inputs and the three enable inputs select one of eight output lines. Two active-low and one active-high enable inputs reduce the need for external gates or inverters when expanding. A 24-line decoder can be implemented without external inverters and a 32-line decoder requires only one inverter. An enable input can be used as a data input for demultiplexing applications.

The SN74LV138 is available in TI's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

The SN54LV138 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74LV138 is characterized for operation from –40°C to 85°C.



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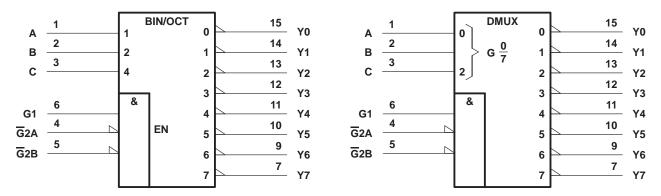


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	FUNCTION TABLE ENABLE INPUTS SELECT INPUTS OUTPUTS												
ENA	BLE INF	PUTS	SEL	ECT INP	UTS				OUT	PUTS			
G1	G2A	G2B	С	В	Α	Y0	Y1	Y2	Y3	Y4	Y5	Y6	Y7
Х	Н	Х	Х	Х	Х	н	Н	Н	Н	Н	Н	Н	Н
Х	Х	Н	Х	Х	Х	н	Н	Н	Н	Н	Н	Н	н
L	Х	Х	Х	Х	Х	н	Н	Н	Н	Н	Н	Н	н
н	L	L	L	L	L	L	Н	Н	Н	Н	Н	Н	Н
н	L	L	L	L	Н	н	L	Н	Н	Н	Н	Н	н
н	L	L	L	Н	L	н	Н	L	Н	Н	Н	Н	н
н	L	L	L	Н	Н	н	Н	Н	L	Н	Н	Н	н
н	L	L	н	L	L	н	Н	Н	Н	L	Н	Н	н
н	L	L	н	L	Н	н	Н	Н	Н	Н	L	Н	Н
н	L	L	н	Н	L	н	Н	Н	Н	Н	Н	L	Н
н	L	L	н	Н	Н	н	Н	Н	Н	Н	Н	Н	L

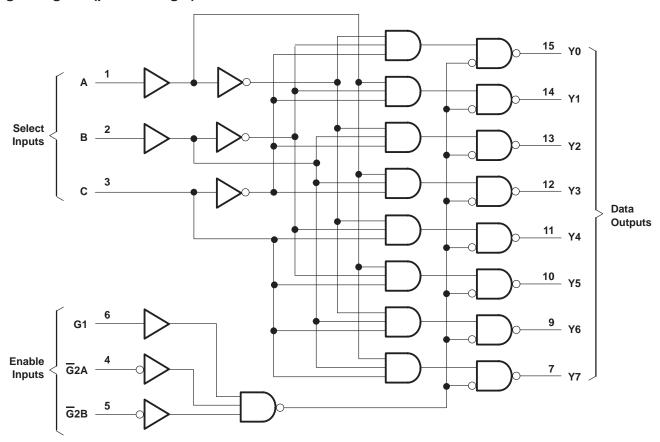
logic symbols (alternatives)[†]



[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, DB, J, PW, and W packages.



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logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

	$\begin{array}{ccc} -0.5 \mbox{ V to } \mbox{V}_{CC} + 0.5 \mbox{ V} \\ -0.5 \mbox{ V to } \mbox{V}_{CC} + 0.5 \mbox{ V} \\ \pm 20 \mbox{ mA} \\ \pm 50 \mbox{ mA} \\ \pm 25 \mbox{ mA} \\ \pm 50 \mbox{ mA} \end{array}$
Storage temperature range, T _{stg}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. This value is limited to 7 V maximum.
- 3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

recommended operating conditions (see Note 4)

			SN54L	SN54LV138		SN54LV138 SN74LV138		UNIT	
			MIN	MAX	MIN	MAX	UNIT		
VCC	Supply voltage		2.7	5.5	2.7	5.5	V		
VIH	High lovel input veltage	V _{CC} = 2.7 V to 3.6 V	2		2		V		
۲IH	High-level input voltage	V _{CC} = 4.5 V to 5.5 V	3.15		3.15		v		
VIL Low-level in	Low level input voltage	V _{CC} = 2.7 V to 3.6 V		0.8		0.8	V		
		V _{CC} = 4.5 V to 5.5 V		1.65		1.65	v		
VI	Input voltage		0	Vcc	0	VCC	V		
VO	Output voltage		0	VCC	0	VCC	V		
lau	I Park land a structure of	V _{CC} = 2.7 V to 3.6 V	00	-6		-6	A		
ЮН	High-level output current	V_{CC} = 4.5 V to 5.5 V	40	-12		-12	mA		
la:		$V_{CC} = 2.7 V \text{ to } 3.6 V$	Y	6		6	A		
IOL	Low-level output current V _{CC} = 4.5 V to 5.5 V			12		12	mA		
$\Delta t/\Delta v$	Input transition rise or fall rate		0	100	0	100	ns/V		
Тд	Operating free-air temperature		-55	125	-40	85	°C		

NOTE 4: Unused inputs must be held high or low to prevent them from floating.



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	TEAT OOL	V +	SN	154LV13	8	SN					
PARAMETER	TEST CO	Vcc [†]	MIN	TYP	MAX	MIN	TYP	MAX	UNIT		
	I _{OH} = -100 μA		MIN to MAX	V _{CC} -0.	2		V _{CC} -0.2	2			
VOH	I _{OH} =6 mA		3 V	2.4			2.4			V	
	I _{OH} = -12 mA		4.5 V	3.6			3.6				
	I _{OL} = 100 μA		MIN to MAX			0.2			0.2		
V _{OL}	I _{OL} = 6 mA	3 V		4	0.4			0.4	V		
	I _{OL} = 12 mA	4.5 V		25	0.55			0.55			
1.			3.6 V		Q	±1			±1	۸	
11	$V_I = V_{CC}$ or GND	5.5 V		2	±1			±1	μA		
100			3.6 V		8	20			20		
ICC	$V_I = V_{CC} \text{ or } GND$ IO	IO = 0	5.5 V	20	ŕ	20			20	μA	
∆ICC	One input at V _{CC} – 0.6 V	Other inputs at V _{CC} or GND	3 V to 3.6 V			500			500	μΑ	
0			3.3 V		2.5			2.5		~ [
Ci	$V_{I} = V_{CC}$ or GND		5 V		2.1			2.1		pF	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

[†] For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

		=				SN54L	_V138				
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} =	= 5 V ± ().5 V	VCC =	: 3.3 V ±	0.3 V	V _{CC} =	: 2.7 V	UNIT
	((001101)	MIN	TYP	MAX	MIN	TYP	MAX	MIN	MAX	1
÷ .	A, B, or C	V		8	x 16		10 🥈	21		26	
^t pd	Enable	ř		8	19		10	23		29	ns

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

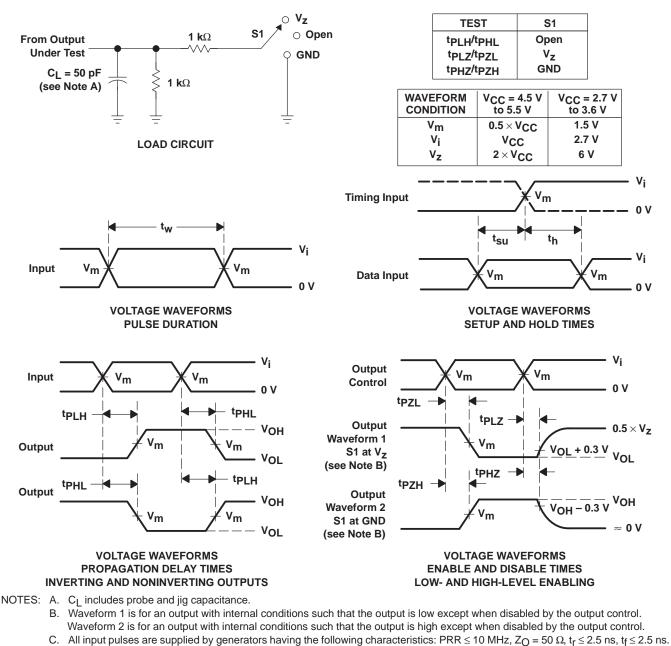
			=-				SN74I	_V138				
	PARAMETER	FROM (INPUT)	TO (OUTPUT)	Vcc	= 5 V ± 0).5 V	V _{CC} =	= 3.3 V \pm	0.3 V	V _{CC} =	2.7 V	UNIT
			(001101)	MIN	TYP	MAX	MIN	TYP	MAX	MIN	MAX	
Γ		A, B, or C	V		8	16		10	21		26	
	tpd	Enable	r		8	19		10	23		29	ns

operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CO	VCC	TYP	UNIT	
	Dower dissinction conscitutes per channel	$C_{1} = 50 \text{ pE}$	f = 10 MHz	3.3 V	47	ρF
Cpd	Power dissipation capacitance per charmer	ower dissipation capacitance per channel $C_L = 50 \text{ pF},$		5 V	49	pr.

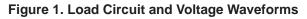


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PARAMETER MEASUREMENT INFORMATION

- D. The outputs are measured one at a time with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .





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